DOCKET NO: 244686US3DIV

## IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF

HIROSHI IGARASHI, ET AL. : ATTN: APPLICATION DIVISION

SERIAL NO: NEW CONT. APPLICATION

FILED: HEREWITH

FOR: WAFER PROCESSING

APPARATUS CAPABLE OF

MAPPING WAFERS

## **PRELIMINARY AMENDMENT**

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Prior to examination on the merits, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2 of this paper.

Remarks/Arguments begin on page 3 of this paper.